

FOR IMMEDIATE RELEASE**Remtec[®] Inc. Appoints Martin B. Nadler,
New Director of Quality Assurance**

Norwood, MA September 17, 2010. Remtec Inc., the leading manufacturer of substrates and packages with Plated Copper on Thick Film (PCTF[®]) technology, has appointed Martin B. Nadler the new Director of Quality Assurance. In making the announcement, Remtec president, Nahum Rapoport said, "Martin Nadler brings us over twenty five years of quality, engineering and management experience in microelectronic ceramic packaging including ceramic and glass-to-metal packages, ceramic substrates and semiconductors. His experience includes work with both original equipment manufacturers and electronics assembly and test subcontractors."



Nadler's extensive experience spans a diverse group of companies including Kyocera International, Augat, Olin Aegis, Ceramtec, Irvine Sensors, Film Microelectronics, Ixion Technologies, CTI-Cryogenics and Netezza Corporation.

In addition to a Bachelor's Degree and graduate studies in engineering management, Nadler is a Certified Quality Engineer, and a Certified ISO 9000 Lead Assessor who has implemented quality programs in accordance with ISO 9001. He has also developed and implemented product assurance programs, Statistical Process Control (SPC) and supplier improvement and certification programs. Rapoport comments further "Martin Nadler is a consummate professional in all areas of quality assurance and is thoroughly qualified to help Remtec achieve the highest quality standards in our industry."

Remtec, a RoHs compliant and ISO 9001: 2008 registered company operates a manufacturing facility totaling 30,000 sq. ft. in Norwood, MA. Remtec provides custom and semi-custom packaging solutions using PCTF technology and DBC substrates for DC power electronics, optoelectronics and MW/RF products in military and commercial industries.